SQS150ELNW

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Vishay Siliconix

RoHS

COMPLIANT HALOGEN

Automotive N-Channel 40 V (D-S) 175 °C MOSFET

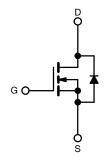


Marking code: Q075

PRODUCT SUMMARY				
V _{DS} (V)	40			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0028			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 V$	0.0045			
I _D (A) ^e	145			
Configuration	Single			

FEATURES

- TrenchFET[®] Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R_g and UIS tested
- Wettable flank terminals
- Low thermal resistance with 0.75 mm profile
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK [®] 1212-8SLW
Lead (Pb)-free and halogen-free	SQS150ELNW (for detailed order number please see <u>www.vishay.com/doc?79771</u>)

ABSOLUTE MAXIMUM RATING	S (T _C = 25 °C, unless	otherwise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	40	V	
Gate-source voltage		V _{GS}	± 20	v	
	T _C = 25 °C	1	145		
Continuous drain current ^e	T _C = 125 °C	I _D	83		
Continuous source current (diode conduction) ^e		I _S	106	А	
Pulsed drain current ^a		I _{DM}	368		
Single pulse avalanche current		I _{AS}	26		
L = 0.1 mH		E _{AS}	33	mJ	
Manian and a disaination 2.8	T _C = 25 °C	_	117	14/	
Maximum power dissipation ^{a, e}	T _C = 125 °C	P _D	39	W	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak temperature) ^c			260		
THERMAL RESISTANCE RATIN	GS				
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount ^b	R _{thJA}	54	00444	
Junction-to-case (drain) d		R _{th-IC}	1.28	°C/W	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. When mounted on 1" square PCB (FR4 material)

c. See solder profile (<u>www.vishay.com/doc?73257</u>). A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

d. As per on JESD51-14

e. Values based on RthJC and TC of 25 °C. Actual values achievable will be dependent on the thermal characteristics of the complete system

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1 For technical questions, contact: <u>automostechsupport@vishav.com</u> Document Number: 62486

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS}=0,\ I_D=250\ \mu A$		40	-	-	v
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	1.7	2.0	2.5	v
Gate-source leakage	I _{GSS}	V _{DS} =	0 V, V_{GS} = ± 20 V	-	-	± 100	nA
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 40 V	-	-	1	μA
		$V_{GS} = 0 V$	V_{DS} = 40 V, T_J = 125 °C	-	-	50	
		$V_{GS} = 0 V$	$V_{DS} = 40 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	-	-	150	
On-state drain current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	20	-	-	Α
		V _{GS} = 10 V	I _D = 10 A	-	0.00232	0.0028	Ω
	P	V _{GS} = 4.5 V	I _D = 10 A	-	0.00346	0.00450	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 10 A, T _J = 125 °C	-	-	0.0045	Ω
		V _{GS} = 10 V	I _D = 10 A, T _J = 175 °C	-	-	0.0056	
Forward transconductance b	g _{fs}	V _{DS}	= 15 V, I _D = 30 A	-	130	-	S
Dynamic ^b		•					
Input capacitance	C _{iss}	V _{GS} = 0 V V	V _{DS} = 25 V, f = 1 MHz	-	2097	2936	pF
Output capacitance	C _{oss}			-	607	850	
Reverse transfer capacitance	C _{rss}			-	50	70	
Total gate charge ^c	Qg			-	40	60	
Gate-source charge ^c	Q _{gs}	V _{GS} = 10 V	V _{GS} = 10 V V _{DS} = 20 V, I _D = 3 A	-	6	-	nC
Gate-drain charge ^c	Q _{gd}				6	-	
Gate resistance	Rg		f = 1 MHz	0.3	0.9	1.6	Ω
Turn-on delay time ^c	t _{d(on)}			-	11	17	
Rise time ^c	t _r	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 20 \text{ V}, R_{\text{L}} = 6.67 \; \Omega \\ I_{\text{D}} \cong 3 \; A, V_{\text{GEN}} = 10 \; V, R_{\text{g}} = 1 \; \Omega \end{array}$		-	4	8	
Turn-off delay time ^c	t _{d(off)}			-	27	41	ns
Fall time ^c	t _f			-	7	11	
Source-Drain Diode Ratings and Charac	teristic ^b						
Pulsed current ^a	I _{SM}			-	-	368	А
Forward voltage	V _{SD}	I _F = 10 A, V _{GS} = 0 V		-	0.82	1.1	V
Body diode reverse recovery time	t _{rr}	V _{DD} = 32 V, I _{FM} = 3 A, di/dt = 100 A/μs, R = 10 Ω, L = 0.3 mH, pulse width = 2 μs		-	36	72	ns
Body diode reverse recovery charge	Q _{rr}			-	30	60	nC
Reverse recovery fall time	t _a			-	18	-	
Reverse recovery rise time	t _b			-	18	-	ns
Body diode peak reverse recovery current	I _{RM(REC)}			-	-1.4	_	А

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

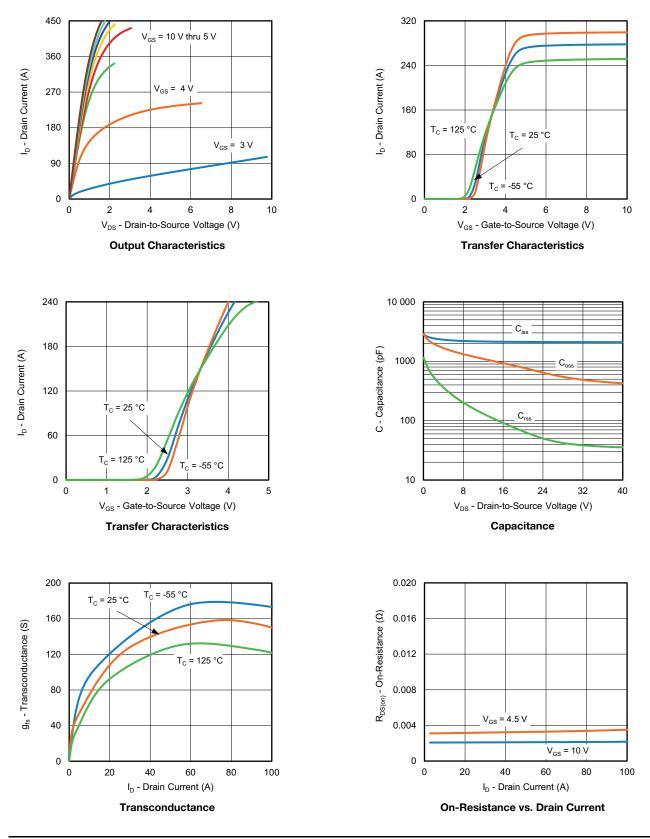
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



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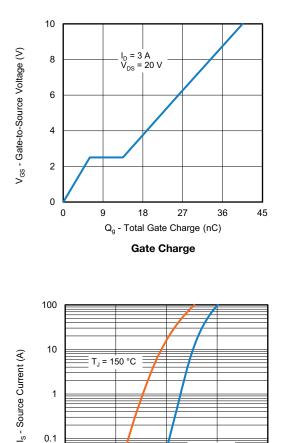
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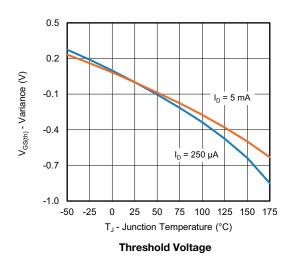
V_{SD} - Source-to-Drain Voltage (V) Source Drain Diode Forward Voltage

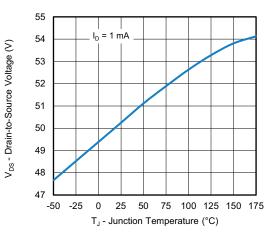
0.6

T_ = 25 °C

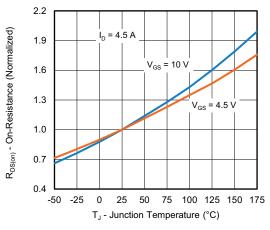
0.9

1.2

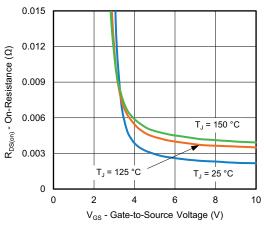




Drain Source Breakdown vs. Junction Temperature



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

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1

0.1

0.01

0

0.3

4

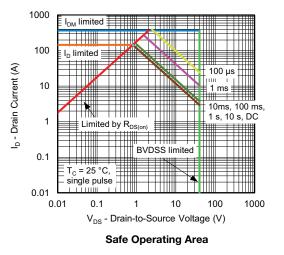
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THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)



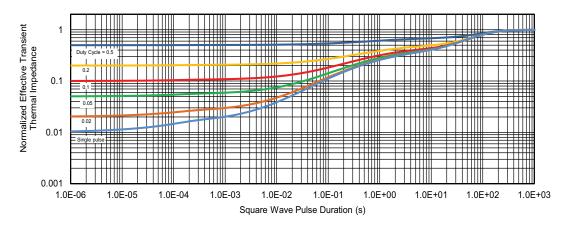
Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

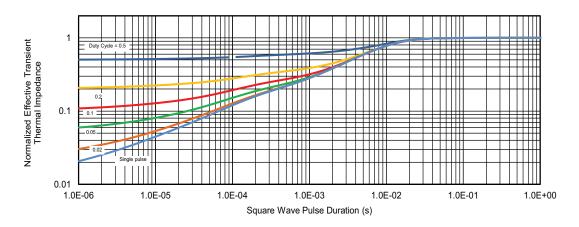


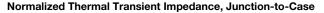
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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient





Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62486.

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RECOMMENDED MINIMUM PADS FOR PowerPAK[®] 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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